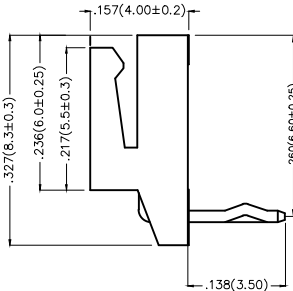
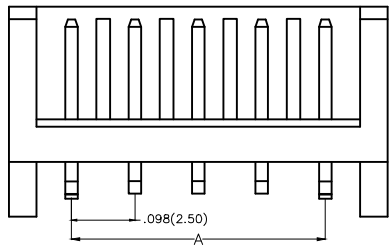
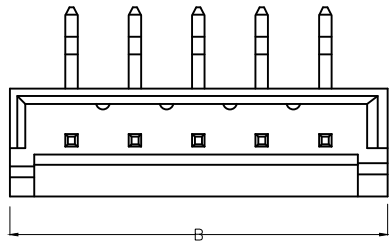


REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD



Electrical
 Current Rating: 3.0A AC(rms)/DC
 Voltage Rating: 250V AC(rms)/DC
 Contact Resistance: 20 mΩ Max
 Insulation Resistance: 1000 MΩ MIN
 Withstanding Voltage: 800V AC r.m.s
 Temperature Range—Operating: -25°C~+85°C

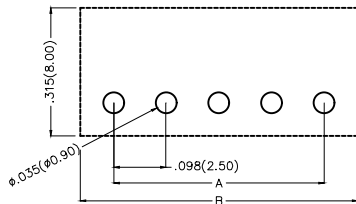
Material and Plating
 Housing: PA66(UL 94V-2)
 Contact Pin: Brass
 Plating: Tin Plated

Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF25006-S02B22W1B	.098(2.50)	.295(7.50)
3	FWF25006-S03B22W1B	.197(5.00)	.394(10.00)
4	FWF25006-S04B22W1B	.295(7.50)	.492(12.50)
5	FWF25006-S05B22W1B	.394(10.00)	.591(15.00)
6	FWF25006-S06B22W1B	.492(12.50)	.689(17.50)
7	FWF25006-S07B22W1B	.591(15.00)	.787(20.00)


Ordering Information

FWF 250 06 - S XX B 2 2 W1 B
 1 2 3 4 5 6 7 8 9 10

1	Category FWF-Wafer	2	Series Number 250-Pitch2.5mm	3	Distinction No. 06	4	Row Option S-Single Row	5	Circuits XX	6	Entry Angle B-90° Angle
7	Plating 2-Tin Plated	8	Material-Resin 2-PA66	9	Color-Resin W1-White	10	Packaging B-PE Bag				



Recommended P.C.Board Layout

THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 01/JUL/13	PART NO. FWF25006-SXXB22W1B	ITEM NO. FWF25006	 Leader Of Industry	
	DESIGN UNITS Inch (metric)	X.±.012(0.30) X.XX±.008(0.20) X.XX±.006(0.15) X.XXX±.004(0.10)	X.'±5" .X'±2" .XX'±1" .XXX'±0.5'	CHECKED BY JACOB	DATE 01/JUL/13	TITLE Wire to Board (Wafer) Pitch 2.5mm 90° Angled (DIP)		REV 0
SCALE 5:1	SIZE A4	DRAWN BY CHERRY		DATE 01/JUL/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z.)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			